

GEMOLOGICAL INSTITUTE

# **ELECTRONIC COPY**

## LABORATORY GROWN DIAMOND REPORT

## PROPORTIONS

May	22,	2024
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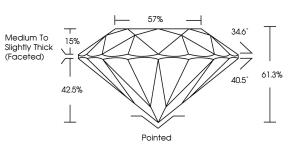
IGI Report Number	LG630465530	
Description	LABORATORY GROWN DIAMOND	
Shape and Cutting Style	ROUND BRILLIANT	
Measurements	6.93 - 6.97 X 4.26 MM	
GRADING RESULTS		
Carat Weight	1.28 CARAT	
Color Grade	D	
Clarity Grade	VVS 2	
Cut Grade	IDEAL	

#### ADDITIONAL GRADING INFORMATION

Polish	EXCELLENT
Symmetry	EXCELLENT
Fluorescence	NONE
Inscription(s)	()写1 LG630465530

Comments: As Grown - No indication of post-growth treatment.

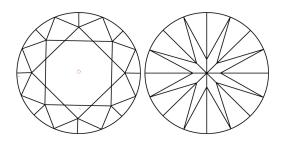
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II



LG630465530

Report verification at igi.org

### **CLARITY CHARACTERISTICS**



#### **KEY TO SYMBOLS**

Red symbols indicate internal characteristics. Green symbols indicate external characteristics.

		_	
llGT LG	630465	530	

Sample Image Used

# COLOR

D E F	GHIJ	Faint	Very Light	Light
CLARITY			SI <sup>1-2</sup>	101
IF	VVS <sup>1-2</sup>	VS <sup>1-2</sup>	SI 1-2	<sup>1-3</sup>
Internally Flawless	Very Very Slightly Included	Very Slightly Included	Slightly Included	Included

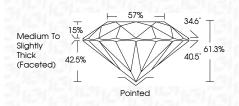


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